# SERIES, < 45 KRad/Si - TID, Commercial Space

Crystal Oscillator | 3.3V | LVDS | 5x3.2mm Ceramic SMD | SmallSat-CubeSat



5x3.2 mm 6 pad Ceramic SMD Package

0.197 ±0.008

(5.0 ±0.2)

0.75 - (1.90) MAX

**Features** 

- Hi-Rel Design and Manufacture
- Proven High Shock Crystal Support
- ECCN EAR 99

- Customer Support & Service
- High-Shock & Vibration Configuration
- Small Hi-Rel Package

- Mission Life Duration Choice
- Designed for > 20,000 Hours Life at +125°C

US Ma	anufact	ture
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standard

marking

shown

- **Design & Configuration Control**
- Radiation Test Data Available upon Request

**Mechanical SPECIFICATIONS** 

Frequency

Part Number YYWW

**←**0.276 ±0.008 **≻** (7.0 ±0.2)

Side View

# **Electrical SPECIFICATIONS**

■ Mission Success | Life Options 6 Months to 5 Years

Mission L	ife / Scree	ning Code	Frequency	Supply	Rise/Fall	Symmetry	Aging	Freque	ncy Stability	/ Vs. Tempe	rature	
6 Months to 1 year	1 Year to 2 years	3 Years to 5 years	Range (MHz)	Current @ 3.3V ±10% (mA)	Time (tr/tf) max (nsec)	min / max (%)	per year max <u>1</u> / (ppm)	-55°C to +125°C (ppm)	-55°C to +125°C (ppm)	-40°C to +105°C (ppm)	-40°C to +85°C (ppm)	
CODE	CODE	CODE						CODE A	CODE B	CODE	CODE	♥ stability vs.
01	02	03	80 to	1.1	3	40/60	±10	±100	±65	±50	±40	temperature code
04	05	06	1 to 7.9	1.3	3	40/60	±10	±100	±65	±50	±40	coue
07	80	09	8 to 15.9	3	3	40/60	±10	±100	±65	±50	±40	
11	12	13	16 to 49.9	6	2	40/60	±10	±100	±65	±50	±40	
14	15	16	50 to 74.9	8	2	40/60	±10	±100	±65	±50	±40	
17	18	19	75 to 94.9	16	2	40/60	±10	±100	±65	±50	±40	
21	22	23	to 250	25	2	40/60	±10	±100	±65	±50	±40	

See reverse side for screening details

LVDS Output, 100 Ω Differential Load Output Voltage - Logic "0" is 0.9V max "Lo"

Output Voltage - Logic "1" is 1.6V max "Hi" Start-up Time: 10 msec max 1/ Frequency Aging Limit

Max change over 30 days ±1.5 ppm ±10 ppm

Projected max change for 1 year after 30 days

0.055 (1.40) -	<b>→</b>     <b>←</b> 2	3	
TYP			
	(	j	0.102 (2.60) TYF
			<del>*************************************</del>
0.047-	6 5	<u> </u>	
(1.10)	<b>←</b> 0.200	) →	
TYP	(5.08	)	
	TYP		

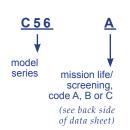
**Bottom View** 

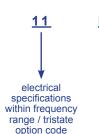
Please Contact Us for Specification Options that are Outside of or beyond those Shown in the Table Above

Standard	Pin Number	Function
PAD CONFIGURATION	1	Ourput Enable (Tri-state)*
* Enable, Logic 1   Disable, Logic 0	2	Ground (case)
Terminate any unused pads,	3	Output
(they are not terminated internally).	4	Supply V (Vcc)

# **How To ORDER**

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2008 **Pb-free RoHS Certified** 

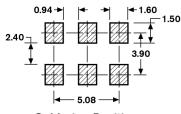






example:

C56A11D-80M00000



Soldering Position





Lower than 3.3 Volt versions of our 5x3.2 mm SMD Crystal Oscillator for Commercial Satellite are available, please inquire!



Screening	Method Options:	Α	В	
Non-Destruct Bond Pull	MIL-STD-883, Method 2023			
Internal Visual	MIL-STD-883, Method 2017	•	•	
Stabilization (Vacuum) Bake	MIL-STD-883, Method 1008, Condition C, 150°C, 24 hours min	•	•	
Temperature Cycling	MIL-STD-883, Method 1010, Condition B, 10 Cycles	•	•	
Constant Acceleration	MIL-STD-883, Method 2001, Condition A (Y1 only, 5000 g's)		•	
PIND Test	MIL-STD-883, Method 2020, Condition B, 5 passes max			
Seal: Fine Leak	MIL-STD-883, Method 1014, Condition A1			
	MIL-STD-202, Method 112, Condition C, 111A		•	
Seal: Gross Leak	MIL-STD-202, Method 112, Condition D	•	•	
Electrical Test	Functional Test Only at +23°C	•	•	
Marking & Serialization	MIL-STD-1285	•	•	
Electrical Test	Nominal Vcc & Extremes and Nominal Temp and Extremes		•	
Burn-in (load)	+125°C, Nominal Supply Voltage and Burn-in load, 160 hours min		•	
Burn-in (no-load)	+125°C, Nominal Supply Voltage and Burn-in load, 48 hours min	•		
Interim Electrical	Functional Test Only			
Burn-in (load)	+125°C, Nominal Supply Voltage and Burn-in load, 160 hours min			
b) Frequency stability is tested	ncy, output waveform, are tested at +23°C ±2°C over the specified temperature range; at both minimum of 5 temperature increments is by lot # and then serial #	•	•	
Radiography	MIL-STD-883, Method 2012			
Frequency Aging	MIL-PRF-55310, +70°C Condition			
Frequency/Temperature Stability	MIL-PRF-55310, Over temperature extremes, 20 points equally spaced			
External Visual & Mechanical	MIL-STD-883, Method 2009	•	•	

•	Designed Specifically for Lower-cost Space Missions				
SmallSat	SmallSat   CubeSat				

Environmental	COMPI	IANCE
Environmental	CUIVIPL	IANGE

Environmental	Specification	Method	Condition	
Vibration – Sine	MIL-STD-202	Method 204	Condition D	20g, 10 to 2 KHz
Vibration – Random	MIL-STD-202	Method 214	Condition 1	30g rms, 10 to 2 KHz Random
Shock	MIL-STD-202	Method 213	Condition I	100g, 6 ms, F:1500, 0.5 ms
Seal Test	MIL-STD-883	Method 1014	Condition A1	Fine Leak
Seal Test	MIL-STD-883	Method 1014	Condition C1	Gross Leak
Temperature Cycling	MIL-STD-883	Method 1010	Condition B	10 Cycles Minimum
Constant Acceleration	MIL-STD-883	Method 2001	Condition A	5000g, Y1 Axis
Thermal Shock	MIL-STD-202	Method 107	Condition B	

### continued...

Environmental	Specification	Method	Condition
Ambient Pressure	MIL-STD-202	Method 105	Condition C
Resistance to Soldering Heat	MIL-STD-202	Method 210	Condition C
Moisture Resistance	MIL-STD-202	Method 106	with 7B Sub-cycle
Salt Atmosphere (corrosion)	MIL-STD-883	Method 1009	Condition A (24 hrs)
Terminal Strength	MIL-STD-202	Method 211	Test Condition D
Solderability	MIL-STD-883	Method 2003	
Resistance to Solvents	MIL-STD-202	Method 215	

note: other options, screening levels and custom test plans available.

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2008 Pb-free RoHS Certified

## **Military Reference Specifications**

MIL-PRF-55310 Oscillators, Crystal Controlled, General Specification For
MIL-PRF-38534 Hybrid Microcircuits, General Specification For
MIL-STD-202 Test Method Standard, Electronic and Electrical Components
Test Methods and Procedures for Microelectronics
MIL-STD-1686 Electrostatic Discharge Control Program for Protection of
Electrical and Electronic Parts, Assemblies and Equipment

# **Materials**

- 1. Package Materials: Ceramic, Alumina 90% min
- 2. External Lead Plating Material: Gold plated Kovar, 0.15  $\mu$ m (60  $\mu$  inch) min, over 2.0  $\mu$ m (80  $\mu$  inch) min Nickel

# **Products for Space Applications**

Contact us for assistance with your specification. We will provide you with the technical support and the required documentation.

Issue 11 12192023



Ph. 714 373 8100 Fx. 714 373 8700